

Data sheet acquired from Harris Semiconductor SCHS056B – Revised February 2003

## **CMOS OR Gates**

### High-Voltage Types (20-Volt Rating)

| CD4071B | Quad   | 2-Input | OR | Gate |
|---------|--------|---------|----|------|
| CD4072B | Dual   | 4-Input | OR | Gate |
| CD4075B | Triple | 3-Input | OR | Gate |

■ CD4071B, CD4072B, and CD4075B OR gates provide the system designer with direct implementation of the positive-logic OR function and supplement the existing family of CMOS gates. The CD4071, CD4072, and CD4075 types are supplied in 14-lead dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic package (E suffix), 14-lead small-outline package (NSR suffix), 14-lead thin shrink small-outline packages (PW and PWR suffixes). The CD4071 and CD4075 also are supplied in 14-lead small-outline packages (M and M96 suffixes).

# CD4071B, CD4072B, CD4075B Types

#### Features:

- Medium-Speed Operation-tpLH, tpHL = 60 ns (typ.) at VDD = 10 V
- = 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Standardized, symmetrical output characteristics
- Noise margin (over full package temperature
  - range) 1 V at VDD = 5 V
  - 2 V at V<sub>DD</sub> = 10 V
  - 2.5 V at VDD = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

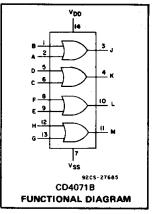
**RECOMMENDED OPERATING CONDITIONS** 

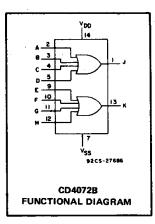
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

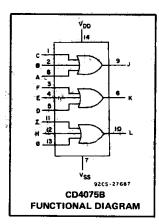
| CHARACTERISTIC  | LIV  | UNITS |   |
|---|------|-------|---|
|   | MIN. | MAX.  |   |
| Supply-Voltage Range (For T <sub>A</sub> = Full Package-Temperature<br>Range) | 3    | 18    | v |

#### STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-                               | CONDITIONS |      |     | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   | UNITS    |       |
|--|------------|------|-----|---------------------------------------|-------|-------|-------|-------|-------------------|----------|-------|
| ISTIC                                    | vo         | VIN  | VDD |                                       |       |       |       |       | +25               | <b>r</b> | OMITS |
|  | (V)        | (V)  | (V) | -55                                   | 40    | +85   | +125  | Min.  | Тур.              | Max.     |       |
| Quiescent Device<br>Current,<br>IDD Max. | -          | 0,5  | 5   | 0.25                                  | 0.25  | 7.5   | 7.5   | -     | 0.01              | 0.25     | μA    |
|  | _          | 0,10 | 10  | 0.5                                   | 0.5   | 15    | 15    | -     | 0.01              | 0,5      |       |
|  | -          | 0,15 | 15  | 1                                     | 1     | 30    | 30    | -     | 0.01              | 1        |       |
|  | -          | 0,20 | 20  | 5                                     | 5     | 150   | 150   | -     | 0.02              | 5        |       |
| Output Low                               | 0.4        | 0,5  | 5   | 0.64                                  | 0.61  | 0.42  | 0,36  | 0.51  | 1                 | -        |       |
| (Sink) Current                           | 0.5        | 0,10 | 10  | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | -        |       |
| IOL Min.                                 | 1.5        | 0,15 | 15  | 4.2                                   | 4     | 2.8   | 2.4   | 3.4   | 6.8               | _        |       |
| Output High                              | 4.6        | 0,5  | 5   | -0.64                                 | -0.61 | -0.42 | -0.36 | -0.51 | -1                | -        | mA    |
| (Source)                                 | 2.5        | 0,5  | 5   | 2                                     | -1.8  | -1.3  | -1.15 | -1.6  | -3.2              | -        |       |
| Current,<br>IOH Min.                     | 9,5        | 0,10 | 10  | -1.6                                  | -1.5  | -1.1  | -0.9  | -1.3  | -2.6              | -        |       |
|  | 13.5       | 0,15 | 15  | -4.2                                  | -4    | -2.8  | -2.4  | -3.4  | -6.8              | -        |       |
| Output Voltage:                          | -          | 0,5  | 5   | 0.05                                  |       |       | -     | 0     | 0.05              | v        |       |
| Low-Level,<br>Voi Max.                   | -          | 0,10 | 10  | 0.05                                  |       |       |       | -     | 0                 |          | 0.05  |
|  | -          | 0,15 | 15  | 0.05                                  |       |       | -     | 0     | 0.05              |          |       |
| Output Voltage:                          |            | 0,5  | 5   | 4.95                                  |       |       | 4.95  | 5     | -                 |          |       |
| High-Level,<br>VOH Min.                  | -          | 0,10 | 10  | 9.95                                  |       |       | 9.95  | 10    | -                 |          |       |
| •0H with                                 | -          | 0,15 | 15  | 14.95                                 |       |       | 14.95 | 15    | -                 |          |       |
| Input Low                                | 0.5, 4.5   | 1    | . 5 | 1.5                                   |       |       | -     | _     | 1.5               |          |       |
| Voltage,<br>VIL Max.<br>Input High       | 1, 9       | _    | 10  | 3                                     |       |       |       | 1     | -                 | 3        | v     |
|  | 1.5,13.5   | ÷    | 15  | 4                                     |       |       | . 1   |       | 4                 |          |       |
|  | 4.5        | ١    | 5   | 3.5                                   |       |       |       | 3.5   | -                 | -        |       |
| Voltage,                                 | 9          |      | 10  | 7                                     |       |       | 7     | _     | -                 |          |       |
| VIH Min.                                 | 13.5       | -    | 15  | 11                                    |       |       |       | 11    |                   | —        |       |
| Input Current<br>IIN Max.                |            | 0,18 | 18  | ±0.1                                  | ±0.1  | ±1    | ±1    |       | ±10 <sup>-5</sup> | ±0.1     | μA    |





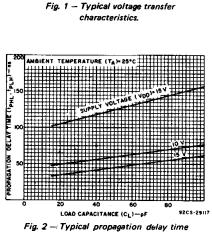


## CD4071B, CD4072B, CD4075B Types

| MAXIMUM RATINGS, Absolute-Maximum Values:                                 |
|---|
| DC SUPPLY-VOLTAGE RANGE, (VDD)  |
| Voltages referenced to V <sub>SS</sub> Terminal)                          |
| INPUT VOLTAGE RANGE, ALL INPUTS   |
| DC INPUT CURRENT, ANY ONE INPUT   |
| POWER DISSIPATION PER PACKAGE (PD):                                       |
| For T <sub>A</sub> = -55°C to +100°C                                      |
| For T <sub>A</sub> = +100°C to +125°CDerate Linearity at 12mW/°C to 200mW |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR                                  |
| FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)               |
| OPERATING-TEMPERATURE RANGE (TA)  |
| STORAGE TEMPERATURE RANGE (Tstg)  |
| LEAD TEMPERATURE (DURING SOLDERING):                                      |
| At distance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max        |

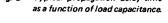
DYNAMIC ELECTRICAL CHARACTERISTICS at  $T_A = 25^{\circ}C$ , input  $t_r$ ,  $t_f = 20$  ns, and CL = 50 pF, RL = 200 k $\Omega$ 

| CHARACTERISTIC   | TEST CONDITIONS                       |                          | ALL TYPES<br>LIMITS |                  |    |
|--|---------------------------------------|--------------------------|---------------------|------------------|----|
|  | · · · · · · · · · · · · · · · · · · · | V <sub>DD</sub><br>VOLTS | TYP.                | MAX.             |    |
| Propagation Delay Time,<br><sup>t</sup> PHL <sup>, t</sup> PLH |                                       | 5<br>10<br>15            | 125<br>60<br>45     | 250<br>120<br>90 | ns |
| Transition Time,<br><sup>t</sup> THL <sup>, t</sup> TLH        |                                       | 5<br>10<br>15            | 100<br>50<br>40     | 200<br>100<br>80 | ns |
| Input Capacitance, CIN   | Any Input                             | 1 - 1                    | 5                   | 7.5              | pF |



3

COMMERCIAL CMOS HIGH VOLTAGE ICS



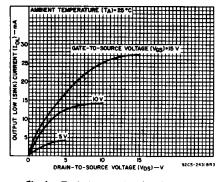
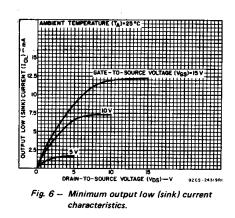


Fig. 4 - Typical output low (sink) current characteristics.



1 (6,8,13) (4,10,11) (5,9,12) E PROTECTED 9205 - 29114 vss

Fig. 3 - Schematic diagram for CD4071B (1 of 4 identical gates).

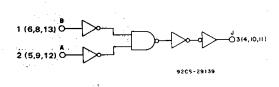
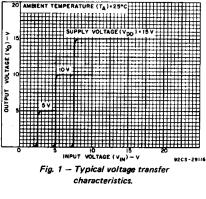
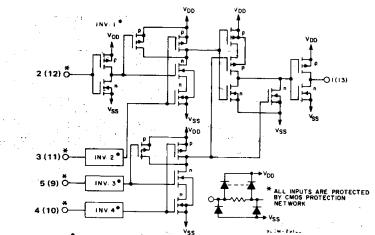


Fig. 5 -/ Logic diagram for CD4071B (1 of 4 identical gates).



DUTPUT

## CD4071B, CD4072B, CD4075B Types



•INVERTERS 2,3 AND 4 ARE IDENTICAL TO INVERTER 1. Fig. 7 - Schematic diagram for CD4072B (1 of 2 identical gates).

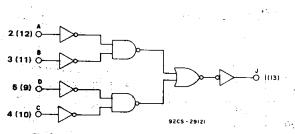


Fig. 9 - Logic diagram for CD4072B (1 of 2 identical gates).

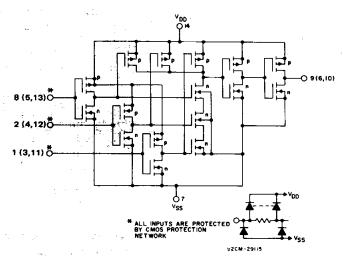
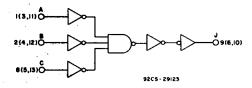
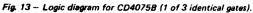
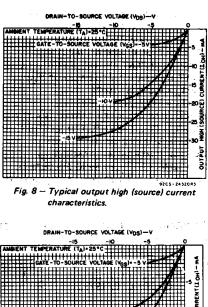
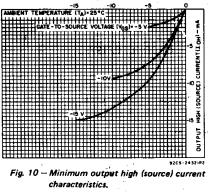


Fig. 11 - Schematic diagram for CD4075B (1 of 3 identical gates).









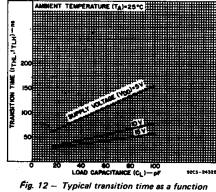


Fig. 12 — Typical transition time as a function of load capacitance.

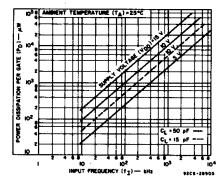
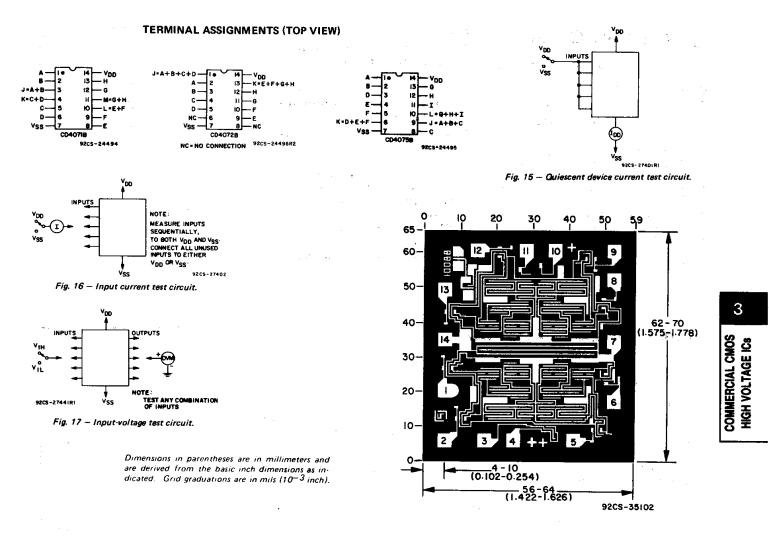
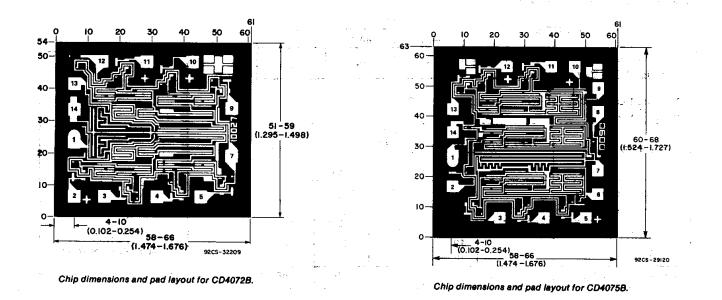


Fig. 14 – Typical dyanamic power dissipation as a function of frequency.

CD4071B, CD4072B, CD4075B Types



Chip dimensions and pad layout for CD4071B.



J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

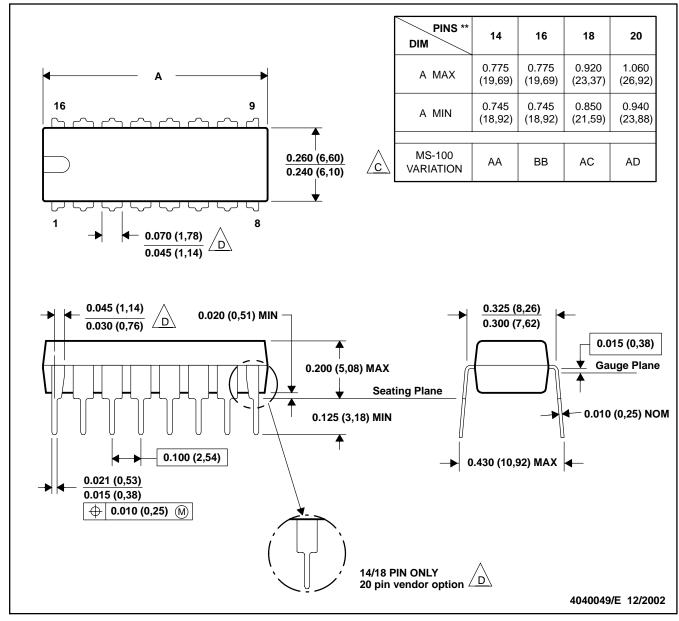
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MPDI002C - JANUARY 1995 - REVISED DECEMBER 20002

### N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

/д.

B. This drawing is subject to change without notice.

/C Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

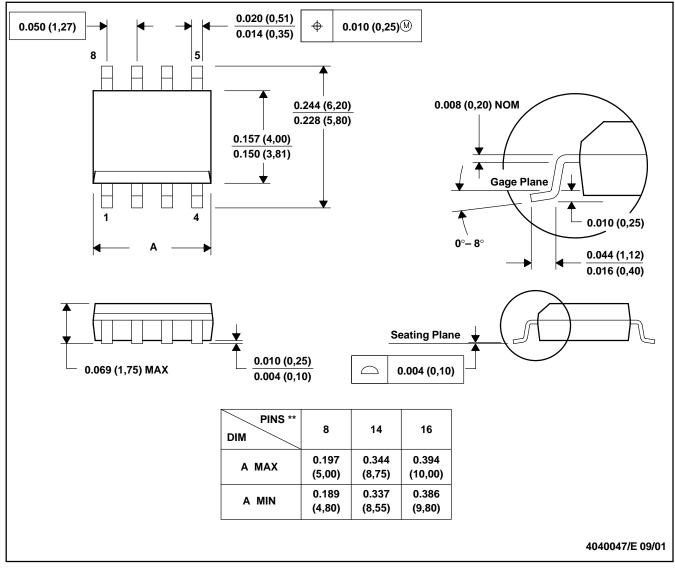


## **MECHANICAL DATA**

MSOI002B - JANUARY 1995 - REVISED SEPTEMBER 2001

#### PLASTIC SMALL-OUTLINE PACKAGE

### D (R-PDSO-G\*\*) 8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012



## MECHANICAL DATA

### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



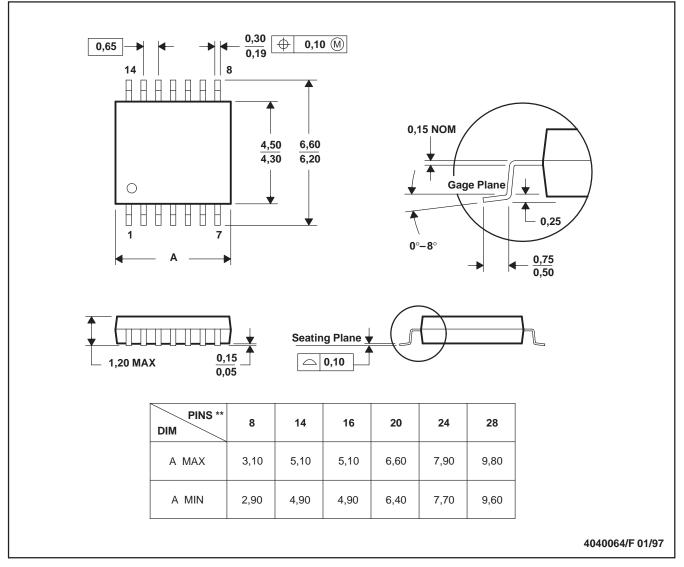
## **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

## PW (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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